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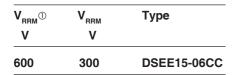
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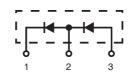
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# HiPerDynFRED™ Epitaxial Diode ISOPLUS220™

**Electrically Isolated Back Surface** 

$I_{\sf FAV}$	=	15 A
$V_{RRM}$	=	600 V
t <sub>rr</sub>	=	30 ns



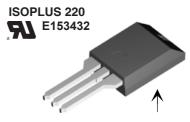


Symbol	Conditions	Maximum Ratings
I <sub>FRMS</sub>		35 A
$I_{FAVM}^{}$	$T_C = 115$ °C; rectangular, $d = 0.5$	15 A
I <sub>FSM</sub>	$T_{VJ} = 45^{\circ}C$ ; $t_p = 10 \text{ ms (50 Hz), sine}$	110 A
E <sub>AS</sub>	$T_{VJ} = 25$ °C; non-repetitive $I_{AS} = 2.5$ A; L = 180 $\mu$ H	0.8 mJ
I <sub>AR</sub>	$V_A = 1.5 \cdot V_R \text{ typ.}$ ; f = 10 kHz; repetitive	0.2 A
T <sub>VJ</sub>		-55+175 °C
$T_{VJM}$		175 °C
$T_{stg}$		-55+150 °C
T <sub>L</sub>	1.6 mm (0.063 in) from case for 10 s	260 °C
$\mathbf{P}_{tot}$	$T_{c} = 25^{\circ}C$	.95 W
V <sub>ISOL</sub>	50/60 Hz RMS; I <sub>ISOL</sub> ≤ 1 mA	2500 V~
F <sub>c</sub>	Mounting force	1165 / 2.515 N / lb
Weight	typical	2 g

Symbol	Conditions	Chara typ.	acteristic max.	Values
I <sub>R</sub> <sup>②</sup>	$T_{VJ} = 25^{\circ}C$ $V_{R} = V_{RRM}$		100	μΑ
	$T_{VJ} = 25$ °C $V_R = V_{RRM}$ $T_{VJ} = 150$ °C $V_R = V_{RRM}$		0.5	mA
V <sub>F</sub>	$I_F = 15 \text{ A};$ $T_{VJ} = 125^{\circ}\text{C}$ $T_{VJ} = 25^{\circ}\text{C}$		1.25 1.7	V
R <sub>thJC</sub>		0.6	1.6	K/W K/W
t <sub>rr</sub>	$I_F = 1 \text{ A}$ ; -di/dt = 200 A/ $\mu$ s; $V_R = 30 \text{ V}$	30		ns
I <sub>RM</sub>	$V_R = 100 \text{ V}; \ I_F = 25 \text{ A}; -di_F/dt = 100 \text{ A/}\mu\text{s}$ $T_{V,I} = 100^{\circ}\text{C}$	2	2.7	А

Notes: Data given for  $T_{VJ} = 25^{\circ}C$  and per diode unless otherwise specified

- ① Diodes connected in series
- $\odot$  Pulse test: pulse Width = 5 ms, Duty Cycle < 2.0 %



Isolated back surface\*

#### Features

- Silicon chip on Direct-Copper-Bond substrate
  - High power dissipation
- Isolated mounting surface
- 2500V electrical isolation
- Low cathode to tab capacitance (<15pF)</li>
- · Planar passivated chips
- · Very short recovery time
- Extremely low switching losses
- Low I<sub>RM</sub>-values
- · Soft recovery behaviour
- Epoxy meets UL 94V-0

#### **Applications**

- Antiparallel diode for high frequency switching devices
- · Antisaturation diode
- Snubber diode
- Free wheeling diode in converters and motor control circuits
- Rectifiers in switch mode power supplies (SMPS)
- · Inductive heating
- Uninterruptible power supplies (UPS)
- · Ultrasonic cleaners and welders

#### **Advantages**

- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low  $I_{\text{RM}}$  reduces:
- Power dissipation within the diode
- Turn-on loss in the commutating switch

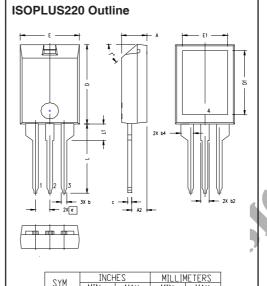
See DSEP 15-03A data sheet for characteristic curves.

Recommended replacement: DSEE29-06CC

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IXYS reserves the right to change limits, test conditions and dimensions.





MY2	TINCHES		MITETIME LEK?	
2 I M	MIN	MAX	MIN	MAX
Α	.157	.197	4.00	5.00
A2	.098	.118	2.50	3.00
b	.035	.051	0.90	1.30
b2	.049	.065	1.25	1.65
b4	.093	.100	2.35	2.55
С	.028	.039	0.70	1.00
D	.591	.630	15.00	16.00
D1	.472	.512	12.00	13.00
E	.394	.433	10.00	11.00
E1	.295	.335	7.50	8.50
е	.100 BASIC		2.55 BASIC	
L	.512	.571	13.00	14.50
L1	.118	.138	3.00	3.50
T°			42.5°	47.5°

#### NOTE:

- 1. Bottom heatsink (Pin 4) is electrically isolated from Pin 1, 2 or 3.
- 2. Pin connections:
  - 1 Cathode
  - 2 Anode/Cathode
  - 3 Anode